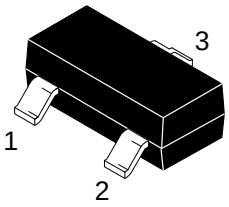
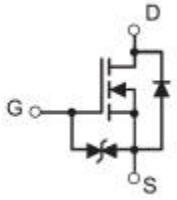
20V/0.8A N-Channel MOSFET

Product Summary

BVDSS	20	V
ID	0.8	A
RDSON@VGS=4.5V	220	mΩ
RDSON@VGS=2.5V	290	mΩ

SOT-23





1. GATE
2. SOURCE
3. DRAIN

Features

- Lead Free Product is Acquired
- Surface Mount Package
- N-Channel Switch with Low RDS(on)
- Operated at Low Logic Level Gate Drive
- ESD Protected Up to 2.0KV (HBM)

Applications

- Load/Power Switching
- Interfacing Switching
- Battery Management for Ultra Small Portable Electronics
- Logic Level Shift

Ordering Information:

Product	Package	Marking	Packing
M3134KD	SOT-23	34K	3000PCS/Reel

Maximum ratings (T_a=25℃ unless otherwise noted)

Parameter		Symbol	Value	Unit
Drain - Source Voltage		V_{DS}	20	V
Gate - Source Voltage		V_{GS}	±12	V
Continuous Drain Current	T_C = 25℃	I_D	0.8	A
Continuous Drain Current	T_A = 75℃		0.4	A
Pulsed Drain Current [1]		I_{DM}	2	A
Power Dissipation [2]		P_D	150	mW
Thermal Resistance from Junction to Ambient [2]		$R_{\theta JA}$	833	℃/W
Junction Temperature		T_J	150	℃
Storage Temperature		T_{STG}	-55~ +150	℃

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Maximum ratings (T_a=25℃ unless otherwise noted)

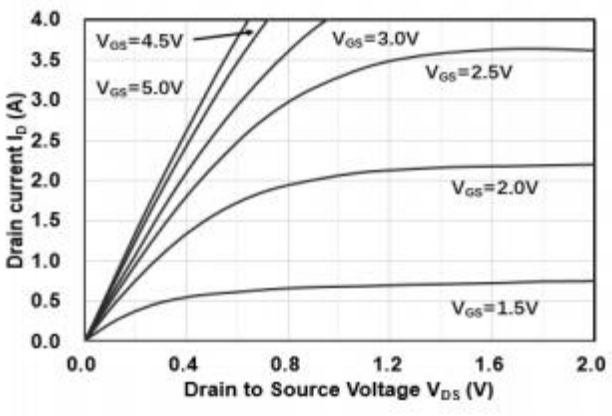
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Static Characteristics						
Drain - Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250μA	20			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 20V, V_{GS} = 0V			1	μA
Gate - Body Leakage Current	I_{GSS}	V_{GS} = ± 10V, V_{DS} = 0V			±10	μA
Gate Threshold Voltage [3]	$V_{GS(th)}$	V_{DS} = V_{GS} , I_D = 250μA	0.4	0.7	1	V
Drain-source On-resistance [3]	$R_{DS(on)}$	V_{GS}= 4.5V, I_D=0.5A		220	350	mΩ
		V_{GS}= 2.5V, I_D=0.45A		290	450	
		V_{GS}= 1.8V, I_D=0.4A		450	700	
Dynamic Characteristics [4]						
Input Capacitance	C_{iss}	V_{DS}=10V,V_{GS}=0V,f=1MHZ		33		pF
Output Capacitance	C_{oss}			20		
Reverse Transfer Capacitance	C_{rss}			10		
Gate Resistance	R_g	f=1MHz, Open Drain		50		Ω
Switching Characteristics [4]						
Total Gate Charge	Q_g	V_{GS}=4.5V,V_{DS}=10V,I_D=0.5A		0.8		nC
Gate-source Charge	Q_{gs}			0.3		
Gate-drain Charge	Q_{gd}			0.15		
Turn-on Delay Time	$t_{d(on)}$	V_{GS}=4.5V,V_{DD}=10V,R_G=10Ω , I_D=500mA		4		ns
Turn-on Rise Time	t_r			18.8		
Turn-off Delay Time	$t_{d(off)}$			10		
Turn-off Fall Time	t_f			23		
Source - Drain Diode Characteristics						
Diode Forward Voltage [3]	V_{SD}	V_{GS} = 0V, I_S = 0.5A			1.2	V

Notes :

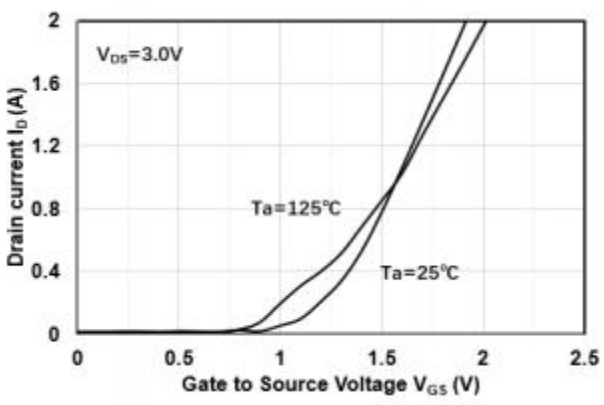
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. This test is performed with no heat sink at Ta=25℃.
3. Pulse Test : Pulse Width≤300μs, Duty Cycle≤0.5%.
4. These parameters have no way to verify.

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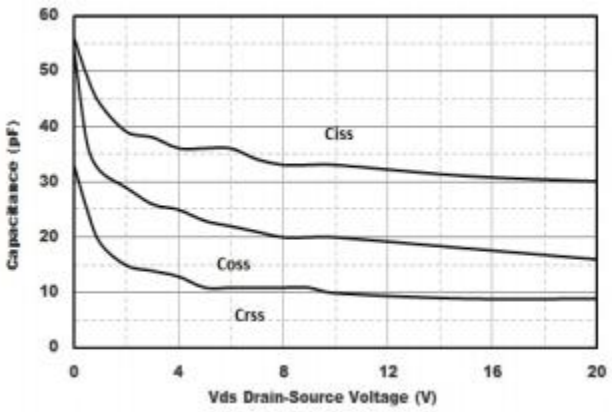
Typical Characteristic



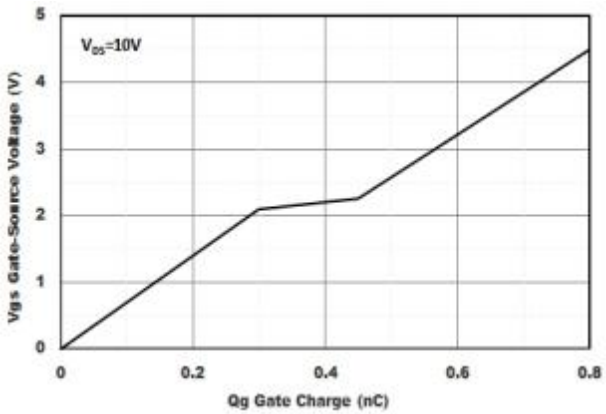
Output Characteristics



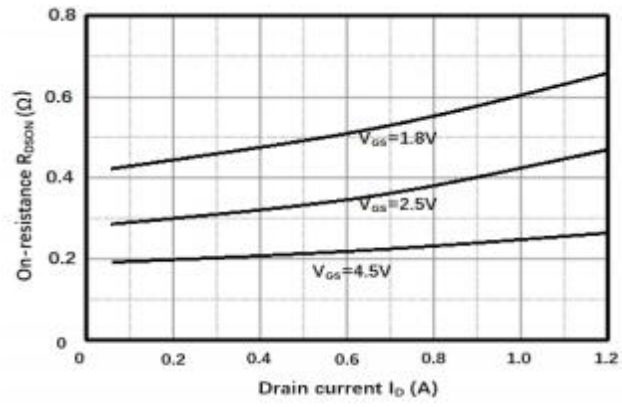
Transfer Characteristics



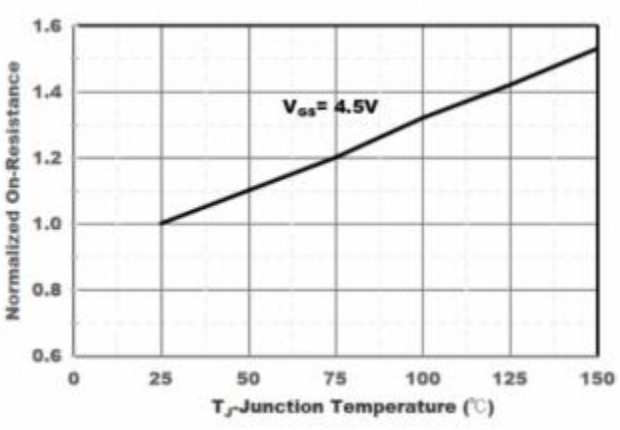
Capacitance Characteristics



Gate Charge

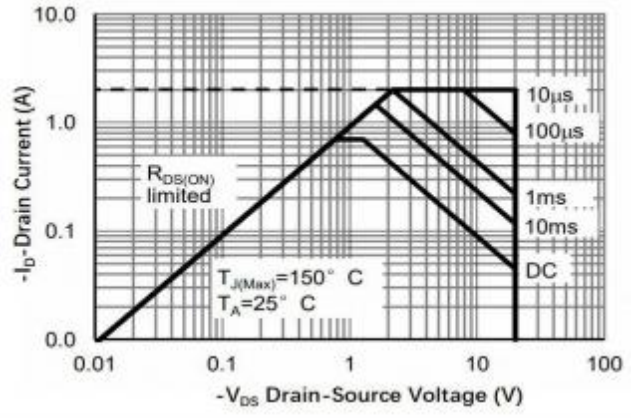


Drain-Source on Resistance

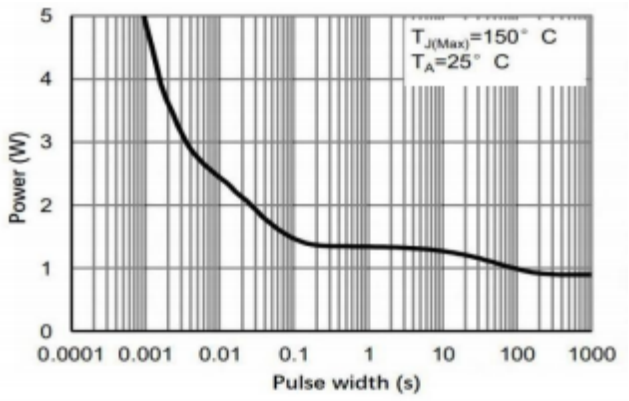


Drain-Source on Resistance

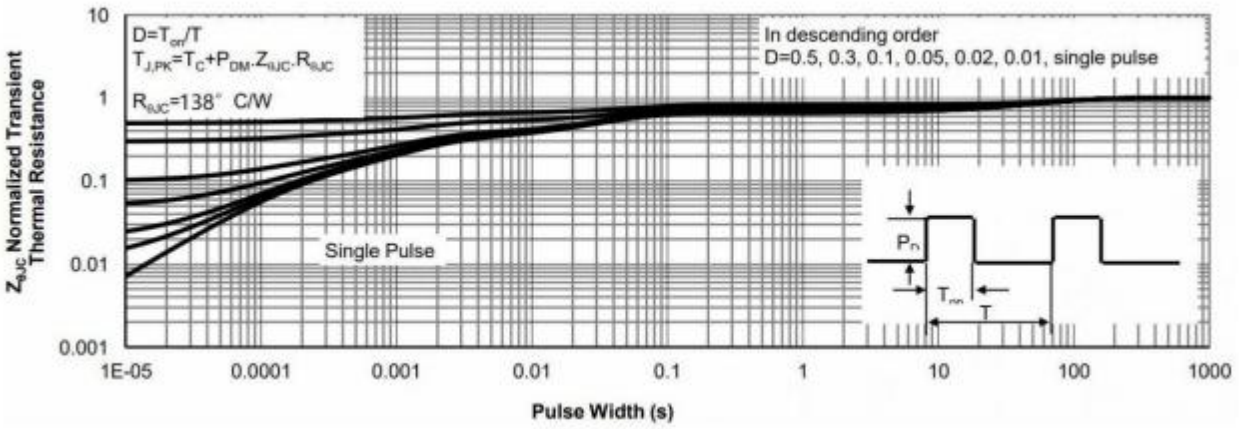
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Safe Operation Area



Pulse Power Rating Junction-to Ambient

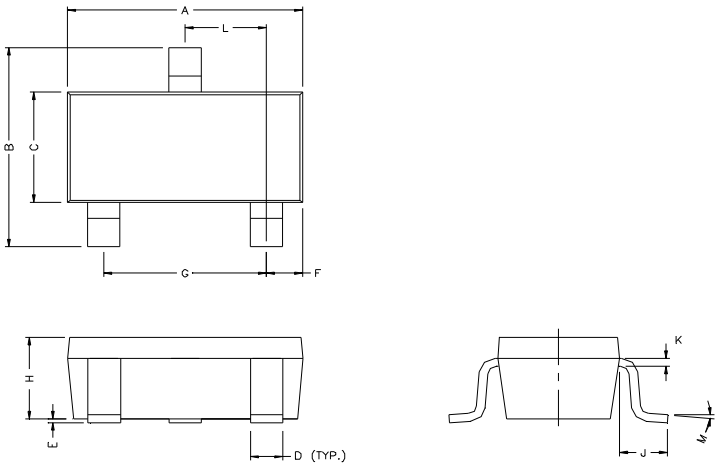


Normalized Maximum Transient Thermal Impedance

20V/0.8A N-Channel MOSFET

Dimension outline Unit:mm

SOT23



REF.	Millimeter		REF.	Millimete	
	Min.	Max.		Min.	Max.
A	2.80	3.00	G	1.80	2.00
B	2.30	2.50	H	0.90	1.1
C	1.20	1.40	K	0.10	0.20
D	0.30	0.50	J	0.35	0.70
E	0	0.10	L	0.92	0.98
F	0.45	0.55	M	0°	10°

SOT-23 Suggested Pad Layout

